# 74AHC125-Q100; 74AHCT125-Q100

Quad buffer/line driver; 3-state

Rev. 1 — 5 June 2012

Product data sheet

## 1. General description

The 74AHC125-Q100; 74AHCT125-Q100 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard JESD7-A.

The 74AHC125-Q100; 74AHCT125-Q100 provides four non-inverting buffer/line drivers with 3-state outputs. The 3-state outputs (nY) are controlled by the output enable input (nOE). A HIGH at nOE causes the outputs to assume a high-impedance OFF-state.

The 74AHC125-Q100; 74AHCT125-Q100 is identical to the 74AHC126-Q100; 74AHCT126-Q100 but has active LOW enable inputs.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Balanced propagation delays
- All inputs have a Schmitt trigger action
- Inputs accept voltages higher than V<sub>CC</sub>
- For 74AHC125-Q100: CMOS input levels
- For 74AHCT125-Q100: TTL input levels
- ESD protection:
  - ◆ MIL-STD-883, method 3015 exceeds 2000 V
  - ♦ HBM JESD22-A114F exceeds 2000 V
  - lacktriangle MM JESD22-A115-A exceeds 200 V (C = 200 pf, R = 0  $\Omega$ )
- Multiple package options

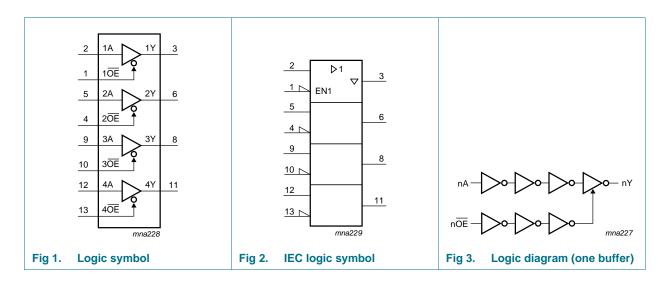


## 3. Ordering information

Table 1. Ordering information

| Type number      | Package           |          |   |          |  |  |  |  |  |  |
|------------------|-------------------|----------|---|----------|--|--|--|--|--|--|
|                  | Temperature range | Name     | Description   | Version  |  |  |  |  |  |  |
| 74AHC125D-Q100   | –40 °C to +125 °C | SO14     | plastic small outline package; 14 leads;  | SOT108-1 |  |  |  |  |  |  |
| 74AHCT125D-Q100  |                   |          | body width 3.9 mm   |          |  |  |  |  |  |  |
| 74AHC125PW-Q100  | –40 °C to +125 °C | TSSOP14  | plastic thin shrink small outline package; 14 leads;                                      | SOT402-1 |  |  |  |  |  |  |
| 74AHCT125PW-Q100 |                   |          | body width 4.4 mm   |          |  |  |  |  |  |  |
| 74AHC125BQ-Q100  | –40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced  | SOT762-1 |  |  |  |  |  |  |
| 74AHCT125BQ-Q100 |                   |          | very thin quad flat package; no leads; 14 terminals; body 2.5 $\times$ 3 $\times$ 0.85 mm |          |  |  |  |  |  |  |

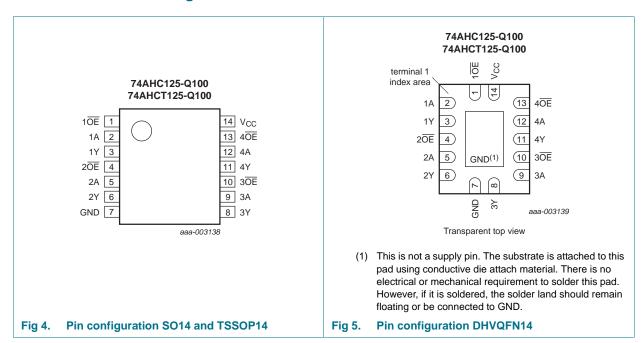
## 4. Functional diagram



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## 5. Pinning information

#### 5.1 Pinning



#### 5.2 Pin description

Table 2. Pin description

| Symbol  | Pin          | Description                      |
|---|--------------|----------------------------------|
| 1 <del>OE</del> , 2 <del>OE</del> , 3 <del>OE</del> , 4 <del>OE</del> | 1, 4, 10, 13 | output enable input (active LOW) |
| 1A, 2A, 3A, 4A  | 2, 5, 9, 12  | data input                       |
| 1Y, 2Y, 3Y, 4Y  | 3, 6, 8, 11  | data output                      |
| GND   | 7            | ground (0 V)                     |
| V <sub>CC</sub>   | 14           | supply voltage                   |

## 6. Functional description

Table 3. Function table[1]

| Control | Input | Output |
|---------|-------|--------|
| nOE     | nA    | nY     |
| L       | L     | L      |
|         | Н     | Н      |
| Н       | X     | Z      |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

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## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min            | Max  | Unit |
|------------------|-------------------------|--|----------------|------|------|
| $V_{CC}$         | supply voltage          |  | -0.5           | +7.0 | V    |
| $V_{I}$          | input voltage           |  | -0.5           | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | $V_1 < -0.5 \text{ V}$   | <u>[1]</u> –20 | -    | mA   |
| l <sub>OK</sub>  | output clamping current | $V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$              | [1] _          | ±20  | mA   |
| Io               | output current          | $V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$                | -              | ±25  | mA   |
| I <sub>CC</sub>  | supply current          |  | -              | 75   | mA   |
| I <sub>GND</sub> | ground current          |  | <b>–75</b>     | -    | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65            | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$ |                |      |      |
|                  | SO14 package            |  | [2] _          | 500  | mW   |
|                  | TSSOP14 package         |  | [3] _          | 500  | mW   |
|                  | DHVQFN14 package        |  | <u>[4]</u> _   | 500  | mW   |

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol              | Parameter             | Conditions                                 | 74AHC | 74AHC125-Q100 |          |     | 74AHCT125-Q100 |          |      |
|---------------------|-----------------------|--|-------|---------------|----------|-----|----------------|----------|------|
|                     |                       |  | Min   | Тур           | Max      | Min | Тур            | Max      |      |
| $V_{CC}$            | supply voltage        |  | 2.0   | 5.0           | 5.5      | 4.5 | 5.0            | 5.5      | V    |
| $V_{I}$             | input voltage         |  | 0     | -             | 5.5      | 0   | -              | 5.5      | V    |
| Vo                  | output voltage        |  | 0     | -             | $V_{CC}$ | 0   | -              | $V_{CC}$ | V    |
| T <sub>amb</sub>    | ambient temperature   |  | -40   | +25           | +125     | -40 | +25            | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise | $V_{CC}$ = 3.3 V $\pm$ 0.3 V               | -     | -             | 100      | -   | -              | -        | ns/V |
|                     | and fall rate         | $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$ | -     | -             | 20       | -   | -              | 20       | ns/V |

<sup>[2]</sup>  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

<sup>[3]</sup>  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

<sup>[4]</sup> P<sub>tot</sub> derates linearly with 4.5 mW/K above 60 °C.

## 9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                | Conditions   |      | 25 °C |       | -40 °C | to +85 °C | -40 °C 1 | to +125 °C | Unit |
|-----------------|--------------------------|--|------|-------|-------|--------|-----------|----------|------------|------|
|                 |                          |  | Min  | Тур   | Max   | Min    | Max       | Min      | Max        |      |
| 74AHC1          | 25-Q100                  | '  |      |       |       |        |           |          |            |      |
| $V_{IH}$        | HIGH-level               | V <sub>CC</sub> = 2.0 V  | 1.5  | -     | -     | 1.5    | -         | 1.5      | -          | V    |
|                 | input voltage            | V <sub>CC</sub> = 3.0 V  | 2.1  | -     | -     | 2.1    | -         | 2.1      | -          | V    |
|                 |                          | V <sub>CC</sub> = 5.5 V  | 3.85 | -     | -     | 3.85   | -         | 3.85     | -          | V    |
| $V_{IL}$        | LOW-level                | V <sub>CC</sub> = 2.0 V  | -    | -     | 0.5   | -      | 0.5       | -        | 0.5        | V    |
|                 | input voltage            | V <sub>CC</sub> = 3.0 V  | -    | -     | 0.9   | -      | 0.9       | -        | 0.9        | V    |
|                 |                          | V <sub>CC</sub> = 5.5 V  | -    | -     | 1.65  | -      | 1.65      | -        | 1.65       | V    |
| $V_{OH}$        | HIGH-level               | $V_I = V_{IH}$ or $V_{IL}$   |      |       |       |        |           |          |            |      |
|                 | output voltage           | $I_O = -50 \mu A$ ; $V_{CC} = 2.0 \text{ V}$   | 1.9  | 2.0   | -     | 1.9    | -         | 1.9      | -          | V    |
|                 |                          | $I_O = -50 \mu A$ ; $V_{CC} = 3.0 \text{ V}$   | 2.9  | 3.0   | -     | 2.9    | -         | 2.9      | -          | V    |
|                 |                          | $I_O = -50 \mu A$ ; $V_{CC} = 4.5 V$   | 4.4  | 4.5   | -     | 4.4    | -         | 4.4      | -          | V    |
|                 |                          | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$  | 2.58 | -     | -     | 2.48   | -         | 2.40     | -          | V    |
|                 |                          | $I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$  | 3.94 | -     | -     | 3.8    | -         | 3.70     | -          | V    |
| $V_{OL}$        | LOW-level                | $V_I = V_{IH}$ or $V_{IL}$   |      |       |       |        |           |          |            |      |
|                 | output voltage           | $I_O = 50 \mu A; V_{CC} = 2.0 V$   | -    | 0     | 0.1   | -      | 0.1       | -        | 0.1        | V    |
|                 |                          | $I_O = 50 \mu A; V_{CC} = 3.0 V$   | -    | 0     | 0.1   | -      | 0.1       | -        | 0.1        | V    |
|                 |                          | $I_O = 50 \mu A; V_{CC} = 4.5 V$   | -    | 0     | 0.1   | -      | 0.1       | -        | 0.1        | V    |
|                 |                          | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$   | -    | -     | 0.36  | -      | 0.44      | -        | 0.55       | V    |
|                 |                          | $I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$   | -    | -     | 0.36  | -      | 0.44      | -        | 0.55       | V    |
| l <sub>OZ</sub> | OFF-state output current | $V_{I} = V_{IH} \text{ or } V_{IL};$<br>$V_{O} = V_{CC} \text{ or GND};$<br>$V_{CC} = 5.5 \text{ V}$ | -    | -     | ±0.25 | -      | ±2.5      | -        | ±10.0      | μА   |
| I <sub>I</sub>  | input leakage<br>current | $V_I = 5.5 \text{ V or GND};$<br>$V_{CC} = 0 \text{ V to } 5.5 \text{ V}$                            | -    | -     | 0.1   | -      | 1.0       | -        | 2.0        | μА   |
| I <sub>CC</sub> | supply current           | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$   | -    | -     | 2.0   | -      | 20        | -        | 40         | μΑ   |
| Cı              | input<br>capacitance     |  | -    | 3.0   | 10    | -      | 10        | -        | 10         | pF   |
| Co              | output<br>capacitance    |  | -    | 4.0   | -     | -      | -         | -        | -          | pF   |

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**Table 6. Static characteristics** ...continued Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions  |      | 25 °C |       | -40 °C | to +85 °C | -40 °C 1 | to +125 °C | Unit |
|------------------|---------------------------|---|------|-------|-------|--------|-----------|----------|------------|------|
|                  |                           |   | Min  | Тур   | Max   | Min    | Max       | Min      | Max        |      |
| 74AHCT           | 125-Q100                  |   |      | 1     |       | 1      | 1         | '        |            |      |
| $V_{IH}$         | HIGH-level input voltage  | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$  | 2.0  | -     | -     | 2.0    | -         | 2.0      | -          | V    |
| $V_{IL}$         | LOW-level input voltage   | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$  | -    | -     | 8.0   | -      | 0.8       | -        | 0.8        | V    |
| $V_{OH}$         | HIGH-level                | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$   |      |       |       |        |           |          |            |      |
|                  | output voltage            | $I_{O} = -50 \mu A$   | 4.4  | 4.5   | -     | 4.4    | -         | 4.4      | -          | V    |
|                  |                           | $I_0 = -8.0 \text{ mA}$   | 3.94 | -     | -     | 3.8    | -         | 3.70     | -          | V    |
| $V_{OL}$         | LOW-level                 | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$   |      |       |       |        |           |          |            |      |
|                  | output voltage            | I <sub>O</sub> = 50 μA  | -    | 0     | 0.1   | -      | 0.1       | -        | 0.1        | V    |
|                  |                           | $I_0 = 8.0 \text{ mA}$  | -    | -     | 0.36  | -      | 0.44      | -        | 0.55       | V    |
| l <sub>OZ</sub>  | OFF-state output current  | per input pin; $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5 \text{ V}$ ; $I_O = 0 \text{ A}$  | -    | -     | ±0.25 | -      | ±2.5      | -        | ±10.0      | μΑ   |
|                  |                           | $V_O = V_{CC}$ or GND;<br>other pins at $V_{CC}$ or GND   |      |       |       |        |           |          |            |      |
| I <sub>I</sub>   | input leakage<br>current  | $V_I = 5.5 \text{ V or GND};$<br>$V_{CC} = 0 \text{ V to } 5.5 \text{ V}$   | -    | -     | 0.1   | -      | 1.0       | -        | 2.0        | μΑ   |
| I <sub>CC</sub>  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A;<br>$V_{CC} = 5.5 \text{ V}$   | -    | -     | 2.0   | -      | 20        | -        | 40         | μΑ   |
| Δl <sub>CC</sub> | additional supply current | per input pin;<br>$V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$<br>other pins at $V_{CC}$ or GND;<br>$V_{CC} = 4.5 \text{ V}$ to 5.5 V | -    | -     | 1.35  | -      | 1.5       | -        | 1.5        | mA   |
| Cı               | input<br>capacitance      |   | -    | 3.0   | 10    | -      | 10        | -        | 10         | pF   |
| Co               | output<br>capacitance     |   | -    | 4.0   | -     | -      | -         | -        | -          | pF   |

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## 10. Dynamic characteristics

**Table 7. Dynamic characteristics** GND = 0 V; For test circuit see <u>Figure 8</u>.

| Symbol           | Parameter                           | Conditions  |            |     | 25 °C  |      | -40 °C | –40 °C to +85 °C |      | o +125 °C | Unit |
|------------------|-------------------------------------|---|------------|-----|--------|------|--------|------------------|------|-----------|------|
|                  |                                     |   |            | Min | Typ[1] | Max  | Min    | Max              | Min  | Max       |      |
| 74AHC1           | 25-Q100                             |   |            |     | '      |      |        |                  | '    |           |      |
| t <sub>pd</sub>  | propagation                         | nA to nY; see Figure 6  | [2]        |     |        |      |        |                  |      |           |      |
|                  | delay                               | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$                                    |            |     |        |      |        |                  |      |           |      |
|                  |                                     | C <sub>L</sub> = 15 pF  |            | -   | 4.4    | 8.0  | 1.0    | 9.5              | 1.0  | 11.5      | ns   |
|                  |                                     | $C_L = 50 pF$   |            | -   | 6.2    | 11.5 | 1.0    | 13.0             | 1.0  | 14.5      | ns   |
|                  |                                     | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$                                    |            |     |        |      |        |                  |      |           |      |
|                  |                                     | C <sub>L</sub> = 15 pF  |            | -   | 3.0    | 5.5  | 1.0    | 6.5              | 1.0  | 7.0       | ns   |
|                  |                                     | $C_L = 50 pF$   |            | -   | 4.3    | 7.5  | 1.0    | 8.5              | 1.0  | 9.5       | ns   |
| t <sub>en</sub>  | enable time                         | nOE to nY; see Figure 7   | [2]        |     |        |      |        |                  |      |           |      |
|                  |                                     | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$                                    |            |     |        |      |        |                  |      |           |      |
|                  | C <sub>L</sub> = 15 pF              |   | -          | 4.7 | 8.0    | 1.0  | 9.5    | 1.0              | 11.5 | ns        |      |
|                  |                                     | $C_L = 50 pF$   |            | -   | 6.8    | 11.5 | 1.0    | 13.0             | 1.0  | 14.5      | ns   |
|                  |                                     | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$                                    |            |     |        |      |        |                  |      |           |      |
|                  |                                     | $C_{L} = 15 \text{ pF}$   |            | -   | 3.3    | 5.1  | 1.0    | 6.0              | 1.0  | 6.5       | ns   |
|                  |                                     | $C_L = 50 pF$   |            | -   | 4.7    | 7.1  | 1.0    | 8.0              | 1.0  | 9.0       | ns   |
| t <sub>dis</sub> | disable time                        | nOE to nY; see Figure 7   | [2]        |     |        |      |        |                  |      |           |      |
|                  |                                     | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$                                    |            |     |        |      |        |                  |      |           |      |
|                  |                                     | C <sub>L</sub> = 15 pF  |            | -   | 6.7    | 9.7  | 1.0    | 11.5             | 1.0  | 12.5      | ns   |
|                  |                                     | $C_L = 50 pF$   |            | -   | 9.6    | 13.2 | 1.0    | 15.0             | 1.0  | 16.5      | ns   |
|                  |                                     | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$                                    |            |     |        |      |        |                  |      |           |      |
|                  |                                     | C <sub>L</sub> = 15 pF  |            | -   | 4.8    | 6.8  | 1.0    | 8.0              | 1.0  | 8.5       | ns   |
|                  |                                     | C <sub>L</sub> = 50 pF  |            | -   | 6.8    | 8.8  | 1.0    | 10.0             | 1.0  | 11.0      | ns   |
| C <sub>PD</sub>  | power<br>dissipation<br>capacitance | $C_L = 50 \text{ pF}$ ; $f_i = 1 \text{ MHz}$ ; $V_I = \text{GND to } V_{CC}$ | <u>[3]</u> | -   | 10     | -    | -      | -                | -    | -         | pF   |

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**Table 7. Dynamic characteristics** ...continued GND = 0 V: For test circuit see Figure 8.

| Symbol           | Parameter                           | Conditions   |     |     | 25 °C  |     | -40 °C 1 | o +85 °C | –40 °C t | o +125 °C | Unit |
|------------------|-------------------------------------|--|-----|-----|--------|-----|----------|----------|----------|-----------|------|
|                  |                                     |  |     | Min | Typ[1] | Max | Min      | Max      | Min      | Max       |      |
| 74AHCT           | 125-Q100                            |  |     |     | '      | •   | '        |          | '        | '         |      |
| t <sub>pd</sub>  | propagation                         | nA to nY; see Figure 6                                   | [2] |     |        |     |          |          |          |           |      |
|                  | delay                               | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$               |     |     |        |     |          |          |          |           |      |
|                  |                                     | C <sub>L</sub> = 15 pF                                   |     | -   | 3.0    | 5.5 | 1.0      | 6.5      | 1.0      | 7.0       | ns   |
|                  |                                     | $C_L = 50 pF$  |     | -   | 4.3    | 7.5 | 1.0      | 8.5      | 1.0      | 9.5       | ns   |
| t <sub>en</sub>  | enable time                         | nOE to nY; see Figure 7                                  |     |     |        |     |          |          |          |           |      |
|                  |                                     | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$               |     |     |        |     |          |          |          |           |      |
|                  |                                     | C <sub>L</sub> = 15 pF                                   |     | -   | 3.4    | 5.1 | 1.0      | 6.0      | 1.0      | 6.5       | ns   |
|                  |                                     | $C_L = 50 pF$  |     | -   | 4.9    | 7.3 | 1.0      | 8.3      | 1.0      | 9.5       | ns   |
| t <sub>dis</sub> | disable time                        | nOE to nY; see Figure 7                                  | [2] |     |        |     |          |          |          |           |      |
|                  |                                     | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$               |     |     |        |     |          |          |          |           |      |
|                  |                                     | C <sub>L</sub> = 15 pF                                   |     | -   | 4.5    | 6.8 | 1.0      | 8.0      | 1.0      | 8.5       | ns   |
|                  |                                     | C <sub>L</sub> = 50 pF                                   |     | -   | 6.5    | 8.8 | 1.0      | 10.0     | 1.0      | 11.0      | ns   |
| $C_{PD}$         | power<br>dissipation<br>capacitance | $C_L$ = 50 pF; $f_i$ = 1 MHz;<br>$V_I$ = GND to $V_{CC}$ | [3] | -   | 12     | -   | -        | -        | -        | -         | pF   |

- [1] Typical values are measured at nominal supply voltage ( $V_{CC} = 3.3 \text{ V}$  and  $V_{CC} = 5.0 \text{ V}$ ).
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

 $t_{\text{en}}$  is the same as  $t_{\text{PZL}}$  and  $t_{\text{PZH}}$ .

 $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}.$ 

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz,  $f_0$  = output frequency in MHz

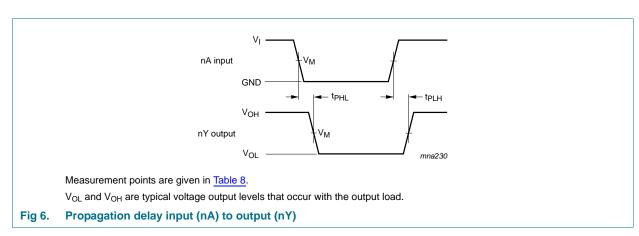
 $C_1$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

#### 11. Waveforms



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Product data sheet Rev. 1 — 5 June 2012

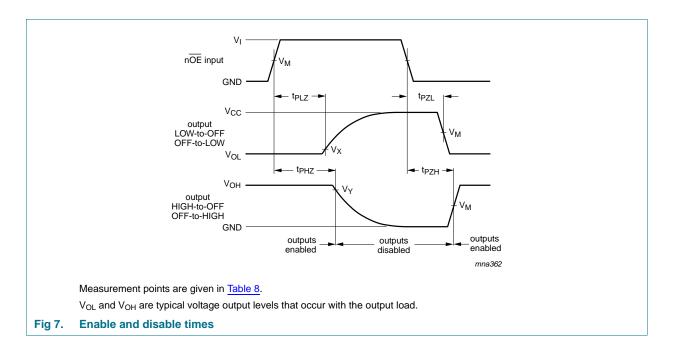


Table 8. Measurement points

| Туре           | Input              | Output             |                         |                 |
|----------------|--------------------|--------------------|-------------------------|-----------------|
|                | V <sub>M</sub>     | V <sub>M</sub>     | V <sub>X</sub>          | V <sub>Y</sub>  |
| 74AHC125-Q100  | 0.5V <sub>CC</sub> | 0.5V <sub>CC</sub> | V <sub>OL</sub> + 0.3 V | $V_{OL}-0.3\ V$ |
| 74AHCT125-Q100 | 1.5 V              | 0.5V <sub>CC</sub> | $V_{OL}$ + 0.3 $V$      | $V_{OL}-0.3\ V$ |

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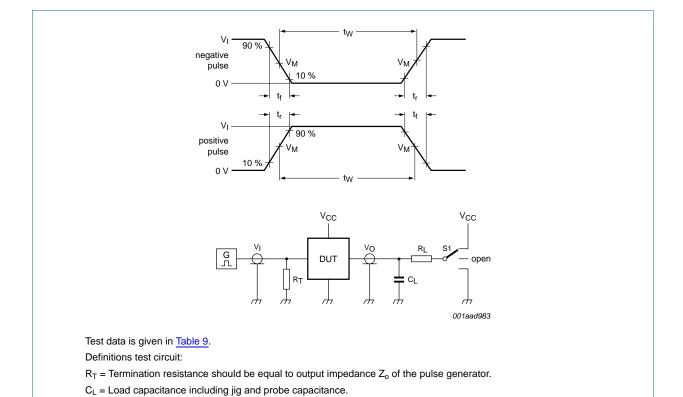


Fig 8. Test circuit for measuring switching times

 $R_L$  = Load resistance. S1 = Test selection switch.

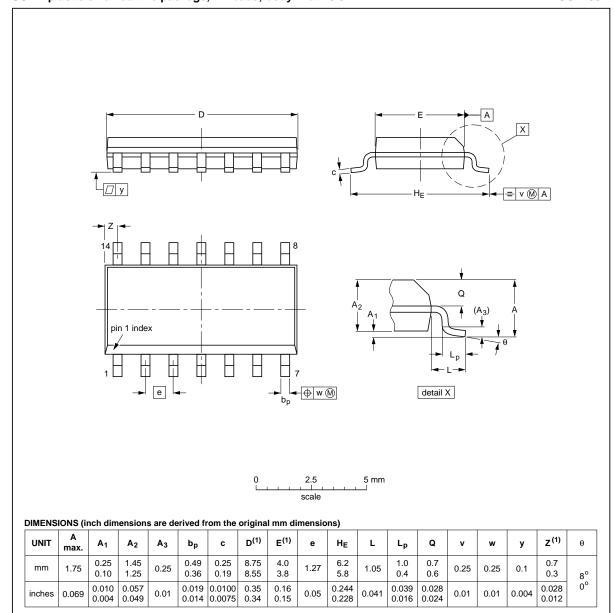
Table 9. Test data

| Туре           | Input          |                                 | Load         |                | S1 position                         |                                     |                                     |
|----------------|----------------|---------------------------------|--------------|----------------|-------------------------------------|-------------------------------------|-------------------------------------|
|                | V <sub>I</sub> | t <sub>r</sub> , t <sub>f</sub> | CL           | R <sub>L</sub> | t <sub>PHL</sub> , t <sub>PLH</sub> | t <sub>PZH</sub> , t <sub>PHZ</sub> | t <sub>PZL</sub> , t <sub>PLZ</sub> |
| 74AHC125-Q100  | $V_{CC}$       | $\leq$ 3.0 ns                   | 15 pF, 50 pF | 1 kΩ           | open                                | GND                                 | $V_{CC}$                            |
| 74AHCT125-Q100 | 3.0 V          | ≤ 3.0 ns                        | 15 pF, 50 pF | 1 kΩ           | open                                | GND                                 | V <sub>CC</sub>                     |

## 12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| VERSION         IEC         JEDEC         JEITA         PROJECTION           SOT108-1         076F06         MS-012         99-12-27- | OUTLINE  |        | REFER  | ENCES | EUROPEAN   | ISSUE DATE                      |
|---|----------|--------|--------|-------|------------|---------------------------------|
| SOT108-1   076E06   MS-012   ++ #+++  | VERSION  | IEC    | JEDEC  | JEITA | PROJECTION | ISSUE DATE                      |
| 03-02-19  | SOT108-1 | 076E06 | MS-012 |       |            | <del>99-12-27</del><br>03-02-19 |

Fig 9. Package outline SOT108-1 (SO14)

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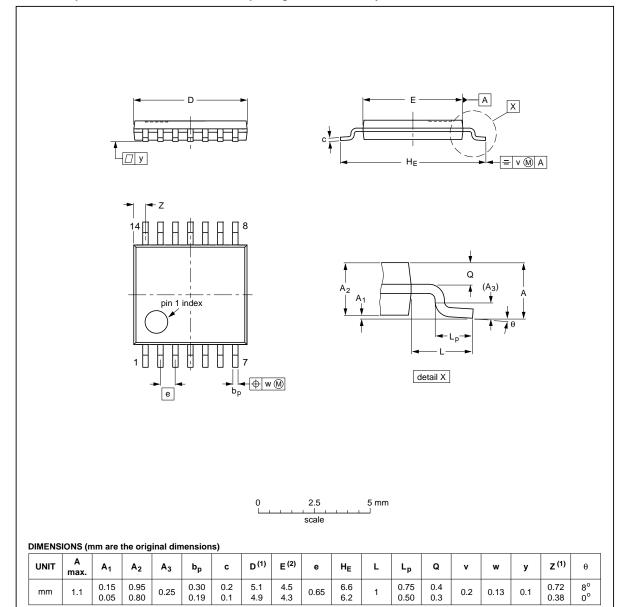
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**Product data sheet** 

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE  | REFERENCES |        |       | EUROPEAN | ISSUE DATE |                                 |
|----------|------------|--------|-------|----------|------------|---------------------------------|
| VERSION  | IEC        | JEDEC  | JEITA |          | PROJECTION | ISSUE DATE                      |
| SOT402-1 |            | MO-153 |       |          |            | <del>99-12-27</del><br>03-02-18 |

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Fig 10. Package outline SOT402-1 (TSSOP14)

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**Product data sheet** 

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

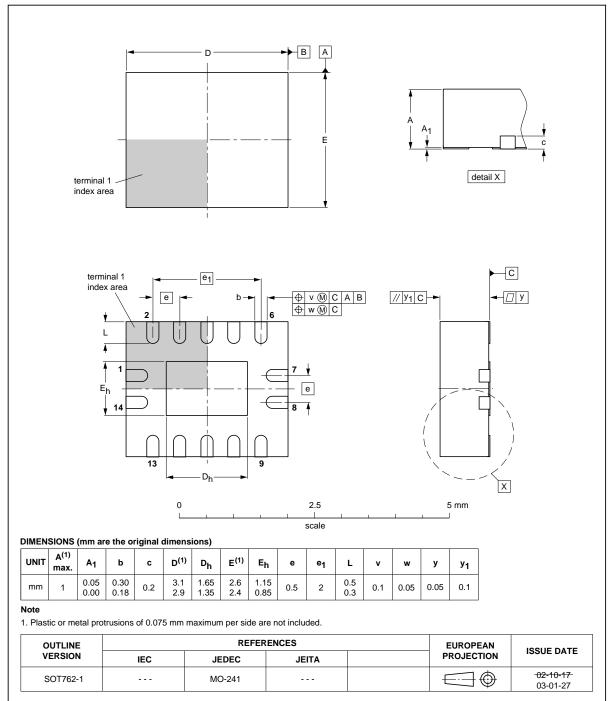


Fig 11. Package outline SOT762-1 (DHVQFN14)

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## 13. Abbreviations

#### Table 10. Abbreviations

| Acronym | Description                                    |
|---------|--|
| CMOS    | Complementary Metal Oxide Semiconductor        |
| LSTTL   | Low-power Schottky Transistor-Transistor Logic |
| ESD     | ElectroStatic Discharge                        |
| HBM     | Human Body Model                               |
| MM      | Machine Model                                  |
| CDM     | Charge-Device Model                            |
| TTL     | Transistor-Transistor Logic                    |
| MIL     | Military                                       |

## 14. Revision history

#### Table 11. Revision history

| Document ID            | Release date | Data sheet status  | Change notice | Supersedes |
|------------------------|--------------|--------------------|---------------|------------|
| 74AHC_AHCT125_Q100 v.1 | 20120605     | Product data sheet | -             | -          |

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|--------------------------------|-------------------|---|
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| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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## 74AHC125-Q100; 74AHCT125-Q100

Quad buffer/line driver; 3-state

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**Product data sheet** 

# 74AHC125-Q100; 74AHCT125-Q100

#### **NXP Semiconductors**

Quad buffer/line driver; 3-state

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